# **Equipment Information Sheet MOS Clean Bench & Tanks**

Manager: Phil Infante 607-254-4926 Backup: Aaron Windsor 607-254-4831 their cell phones during accession noun-leave a message or send them an email.

Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times

## SAFETY **USAGE RESTRICTIONS SCHEDULING/SIGN-UP RESTRICTIONS**

Minimum Tool Time: 0 minutes

## MATERIALS COMPATIBILITY CATEGORY

## **Tool Category 1E: Silicon Based Materials and Select Dieletrics**

Allowed	Not Allowed
Silicon Based Materials only	No Evaporated or Sputtered Films
Si, SiC, SiO <sub>2</sub> substrates	No Metal or Organic Films
All Furnace grown or deposited films	No Glass Substrates
PECVD Films	No III/V Compound Semiconductors
Select ALD dieletrics (SiO <sub>2</sub> , SiN, HfO <sub>2</sub> , HFN)	No High Vapor pressure materials
Spin on Glass and Spin on Dopants	Organic/Biology Molecules prepared-with or without Salt buffers

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

## **Additional Material Restrictions and Exceptions**

Last Updated: 03/20/2019